CAT# LCD-111 WINTEK CORPORATION SPECIFICATIONS FOR LCD MODULE MODEL: WD-C2401P-1GNN

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1.Precautions in Use of LCM

1.1 Handling of LCM

- Don't give external shock.
- Don't apply excessive force on the surface.
- · Liquid in LCD is hazardous substance. Must not lick and swallow, when the liquid is attach to your hand, skin, cloth etc. Wash it out thoroughly and immediately.
- Don't operate it above the absolute maximum rating.
- Don't disassemble the LCM.

1.2 Storage

- Store in an ambient temperature of 5 to 45 °C, and in a relative humidity of 40% to 60%. Don't expose to sunlight or fluorescent light.
- · Storage in a clean environment, free from dust, active gas, and solvent.
- Store in anti-static electricity container.
- Store without any physical load.

1.3 Soldering

- Use the high quality solder. (60-63% tin mixed with lead)
- Iron: no higher than 260°C and less than 3-4 sec during soldering.
- Soldering: only to the I/O terminals.
- Rewining: no more than 3 times.

2. Introduction

Liquid Crystal Displays (LCDs) have widely used in many applications such as industrial measurements, office mechanisms, and household electronic-equipment, etc. LCM (LCD Module) integrates with LCD and driving circuit that is easily to be interfaced by user. This LCM contains a standard built-in dot-matrix font set.

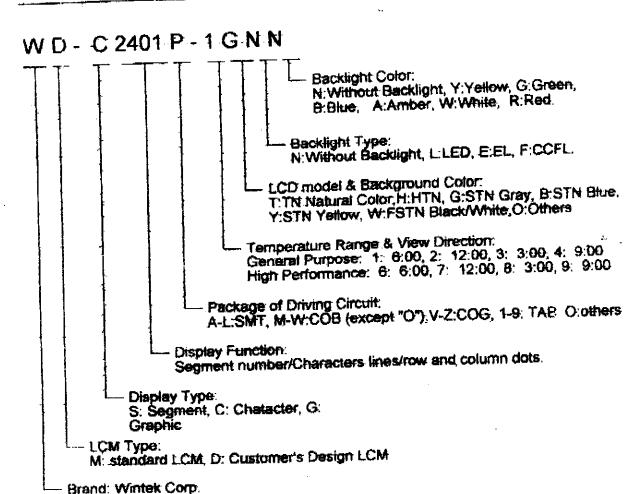
2.1 Applications of LCM

- Telephone.
- Fasimile Mechanism.
- Electronic Typewriter.
- Word Processor.
- Electronic Memo Pads.
- Remote Controller.
- Other Electronic Equipment.

2.2 Features of LCM

- Compact, Thin, and Light.
- Wide View Angle.
- Low Power Consumption.
- High Contrast image.
- Wide Operating Temperature.
- Various Backlight Available.
- High Reliability.
- · Easy interface control.

3. Module Classification Information

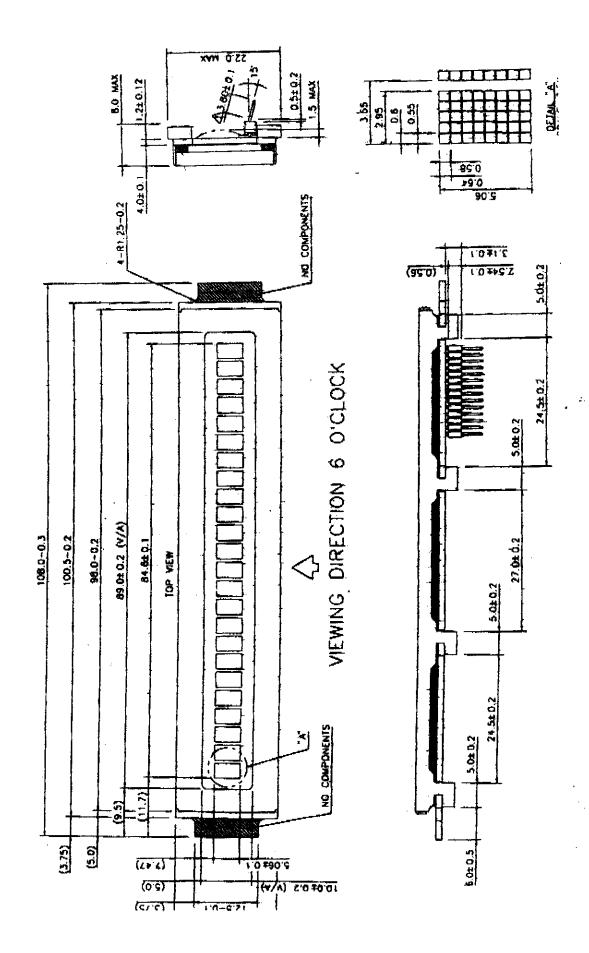


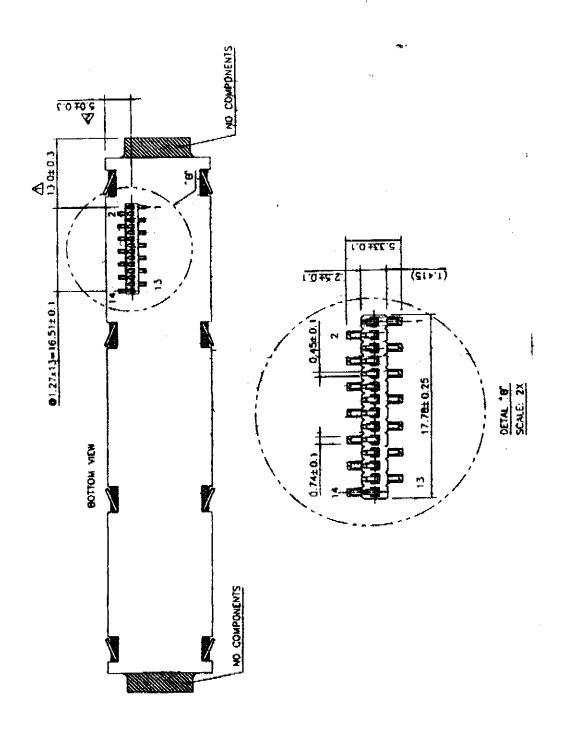
4. Mechanical Specification & Diagram

4.1 Mechanical Specification

ГГЕМ	STANDARD VALUE	UNIT
NUMBER OF CHARACTERS	24 CHARACTERS × 1 LINES	-
CHARACTER FORMAT	5 ×7 DOTS with CURSOR	-
MODULE DIMENSION	108.0(W) ×20.0(H) × 8.0(T)	
EFFECTIVE DISPLAY AREA	89.0(W) × 10.0(H)	mm
CHARACTER SIZE	2.95(W) × 5.06(H)	mm
CHARACTER PITCH	3.55(W) × 5.06(H)	mo
DOT SIZE	0.55(W) × 0.58(H)	mm
DOT PITCH	0.60(W) × 0.64(H)	mu
APPROX. WEIGHT	40	g
CONTROLLER IC	HD66717	
LCD TYPE	STN (GRAY MODE)	
DUTY	1/18	
VIEWING DIRECTION	6 O'clock	
BACK LIGHT		

4.2 Mechanical Diagram





5. Absolute Maximum Ratings

	SYMBOL	MIN.	TYP.	MAX.	UNIT
[LEW		-10		+50	°(.
OPERATING TEMPERATURE	T.())	 		L	°C
STORAGE TEMPERATURE	${ m T_{sr}}$	-20		+60	
	V,	-0.3	-	V _{DD} +0.3	V
INPUT VOLTAGE	V V	-0.3	-	7.0	V
SUPPLY VOLTAGE FOR LOGIC	V _{DD} -V _{SS}		-	15.0	V
SUPPLY VOLTAGE FOR LCD	V _{DD} -V ₀	-0.3			1
STATIC ELECTRICITY	Be sure that	you ar	e grou	nded when	n nandii

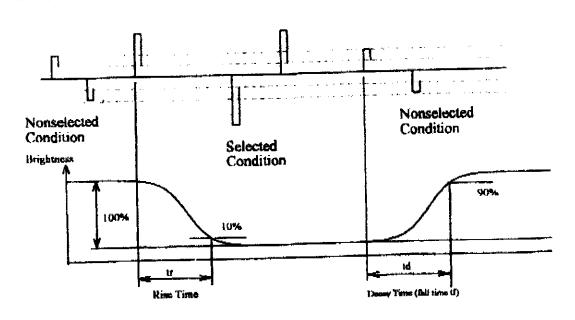
6. Electrical Characteristics

ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
SUPPLY VOLTAGE	V _{DD} -V _{SS}	-	4.75	5.0	5.25	٧
FOR LOGIC SUPPLY VOLTAGE	V _{DD} -V ₀	Ta=0 °C	-	4.8	-	٧
FOR LCD		Ta=25 °C	-	4.5	-	
		Ta=50 °C	-	4.2	-	
INPUT HIGH VOL.	V _{III}	-	0.7V _{DD}	4	V _{DD}	
INPUT LOW VOL.	V _u	_	-0.3		0.15V _{DD}	<u> </u>
OUTPUT HIGH VOL	V _{OH}	₩.	0.75V _{DD}	_		<u> </u>
OUTPUT LOW VOL.	V _{OL}	-	-		0.2V _{DD}	V
SUPPLY CURRENT	I _{DD}	V _{DD} = 5,0 V	-	2.0	4.0	mΛ

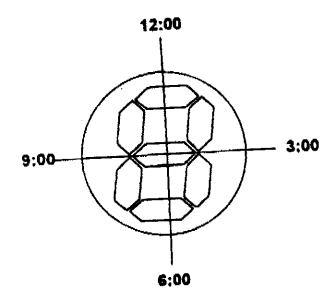
7. Optical Characteristics

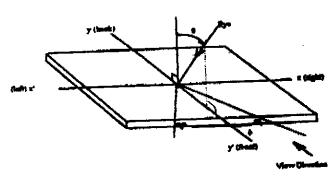
ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
VIEW ANGLE (V)	θ	CR ≥ 2	10	_	40	deg.
VIEW ANGLE (H)	4	CR ≥ 2	-30	_	30	deg
CONTRAST RATIO	CR		-	5	-	
RESPONSE TIME	Ton		-	200	300	mS
RESPONSE TIME	T _{OPT}		-	200	300	mS

8. Optical Definitions

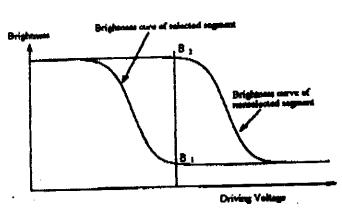


Response Time





View Assis



Persondicular line (8=90*)

Contract ration = Brightness at notacted segment (B2)

Contrast ration (C R)

9. Interface Pin Function

NO	SYMBOL	LEVEL	FUNCTION
1	V _{SS}	LH	GND (0 V)
2	V _{ro}	-	VCC (+5 V ± 5%)
7	ŘEŠET	-	CONTROLLER RESET
4	RS	H/L	REGISTER SELECT SIGNAL
5	R/W	H/L	READ/WRITE SELECTION
6	E	H,H→L	ENABLE SIGNAL
7	DB 0	H/L	DATA BIT 0
8	DB 1	H/L	DATA BIT 1
9	DB 2	H/L	DATA BIT 2
10	DB 3	H/L	DATA BIT 3
11	DB 4	H/L	DATA BIT 4
12	DB 5	H/L	DATA BIT 5
13	DB 6	H/L	DATA BIT 6
14	DB 7	H/L	DATA BIT 7

10. Display Address

Relations between DD RAM addresses and positions on the LCD are shown below. The DD RAM address (ADD) is set in the address counter (AC) and is represented in hexadecimal.

24×1 line display

1 2 3 4 5 10 11 12 13 14 15 16 20 21 22 23 24 >> Display Published

00 01 02 03 04 09 0A 0B 10 11 12 13 17 18 19 1A 1B >> Display Published

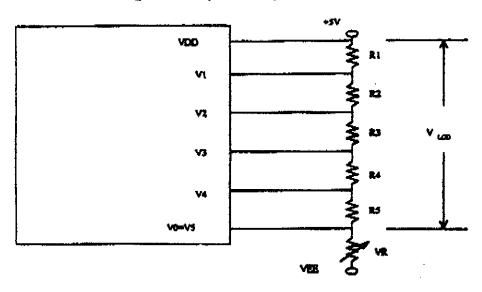
Addresse

11.Description in Block Diagram

- a. Data Resistor (DR): DR is a register used for temporary storage of the date read/write from/into DD RAM and CG RAM.
- b. Instruction Register (IR): IR is a register available for storing the instruction codes and address information of display data (DD) RAM and character generator (CG) RAM.
- c. BUSY FLAG (BF): When the BUSY FLAG is "I", it shows that LCM is in internal operation and it can not accept the next instruction.
- d. Character Generator (CG) ROM: This ROM generates character pattern from 8-bit character code and provides 192 character patterns.
- e. Character Generator (CG) RAM: This RAM allows the user to rewrite the character patterns freely according to the program.
- f. Address Counter (AC): This address counter is used to give the address information of DD RAM and CG RAM.
- g. Display Data (DD) RAM: This display data RAM is used to store the display data expressed by 8-bit character code. The capacity is 80×8 bits and data for 80 characters can be storage.

12. Power Supply for LCD Module

12.1 LCD Driving Source (1/5 Bias)



$$V_{1} = V_{DD} - \frac{1}{5}V_{LCD}$$

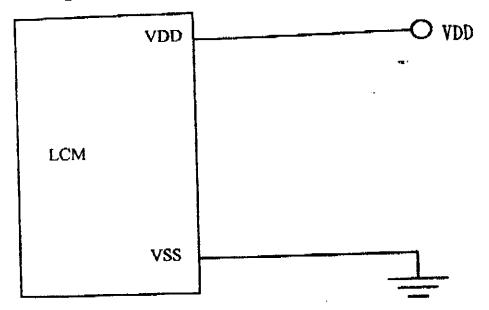
$$V_{2} = V_{DD} - \frac{2}{5}V_{LCD}$$

$$V_{3} = V_{DD} - \frac{3}{5}V_{LCD}$$

$$V_{4} = V_{DD} - \frac{4}{5}V_{LCD}$$

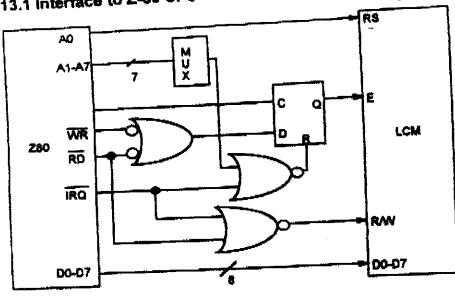
$$V_{5} = V_{DD} - V_{LCD}$$

12.2 Signal Supply Voltage Types

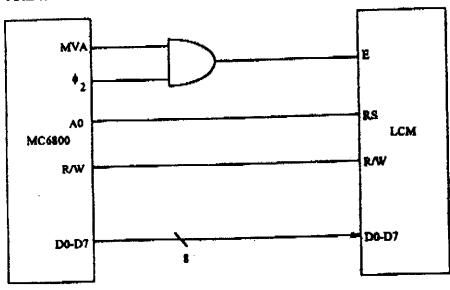


13. Interface to MPU

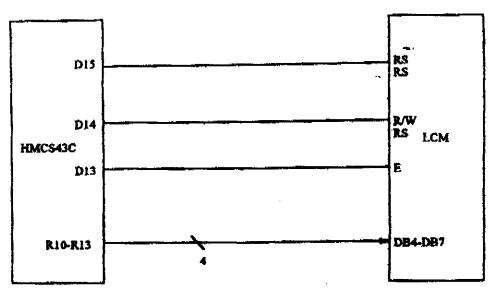
13.1 Interface to Z-80 CPU



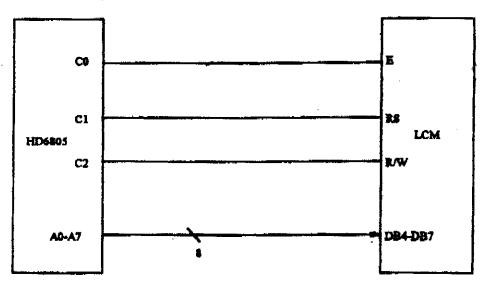
13.2 Interface to MC6800 CPU



13.3 Interface to 4-bit CPU (HMCS43C)

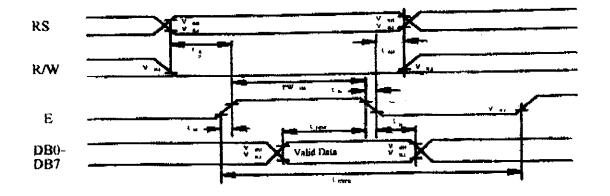


13.4 Interface to HD6805 MP



14. Timing Control

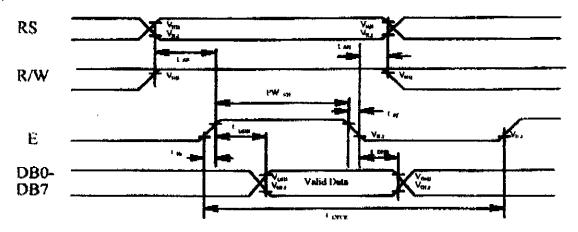
14.1 Write Operation



(Writing data from MPU to LCM) VDD=4.25V to 5.25V

[tem	Symbol	Limit (Min.)	Limit (Max.)	Unit
Enable Cycle Time	CYCE	50X1	-	nS
Enable Pulse Width (High level)	PWEH	230	-	aS
Enable Rise/Fall Time	ter, ter	•	20	nS
Address Set-Up Time (RS,R/W, E)	¹ AS	40	-	2a
Address Hole Time	⁽ AH	30		nS
Data Sct-Up Time	lpsw	80	-	oS
Data Hold Time	ţн	5	-	nS

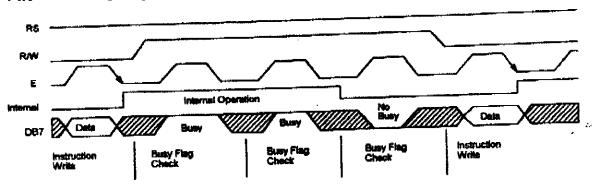
14.2 Read Operation



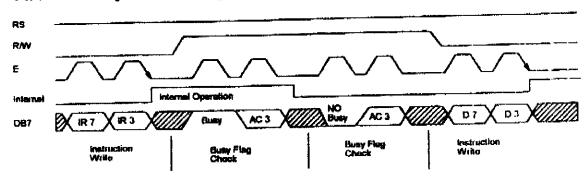
(Reading data from LCM to MPI) VDB-4.25V to 5.25V

Item	Symbol	Limit (Min.)	Limit (Max.)	Umit	
Enable Cycle Time	CYCE	500	-	nS	
Enable Pulse Width (High level)	PWFH	230		<u>nS</u>	
Enable Rise/Fall Time	teo tec		20	nS	
Address Sct-Up Time (RS,R/W, E)	¹ AS	40		08	
Address Hole Time	LAH	30		nS_	
Data Delay Time	^t DDR	-	200	nS	
Data Hold Time	t))HIR	5	-	пS	

14.3 8-bit busy flag check timing



14.4 4-bit busy check timing



(Note) IR 7, IR 3: Instruction 7th bit, 3rd bit; AC3: Address Counter 3 rd bit

15. Character Generator ROM Map

Correspondence between character code and character

Upper 4	0000	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	1100	1101	1110	1111
xx0000	EG RAM (1)	-		Ø	āl	Ů.		Ë	Б	13		1]	İ	Ð	ij	×
xxx0001	(2)	4	i	1	Ĥ		. =	<u>-4</u>	卫	<u>.</u>]:	i	+	Á	Ŀi	Ė	ii
xxx0010	(3)	££	11	2	E	F :	<u>F</u> 1	t ".	出		4.	Ż	Ä	Ò	ä	Ö
xxx0011	(4)	77.79	#	3	I	5	<u>ı</u>	5	3	Л	Ŧ.	3	Ä	Ď	ä	Ċ
ooox0100	(5)	.de.	\$	4	D	T	d	+.	И	Ξ	<u>'B'</u>	F	Ĥ	Ô	ä	ĉ
xxxx0101	(6)	7		5	E		6	1.4	1.1	O	¥	14	Ä	5	Ė	õ
xxxx0110	(7)		8	↓	F	Į,	Ŧ,	1,,1	J	J	i	1	Æ	Ü	*	Ö
200x0111	(8)	4	7	7	G	1,1	9	W	П	•т		*	5	X	· -	-1-
xxxx1000	(1)	†	(8	H	X	b	35	12/		+	60	Ė		ė	*
xxx1001	(2)	4	.)	9	I	V	i	'	L	E	H	1	Ė	i.		1.1
xxxx1010	(3)	-;-				Z		7	1-	1	3	旦	Ë	L	Ë	L
xxxx1011	(4)	4.	- +	. ;	K		k :	{	Ш		*	*	E		ë	I
xxxx1100	(5)	<	-				1	1	Ш	200	H	13	i		i	Li
xxxx1101	(6)	<u>ئ</u> ر			i i		n		ŀ	. 4	1.5		i	Y	li	Ė
xxxx1110) (7)	4			· -		·ŀ		. 1.	Ξ	. [3.	Ï	F	1	ŀ
xxx111	(8)	7						ů	12		1 6		. I	F	1	ÿ

16. User Font Patterns (CG RAM Character)

Character Civin	CXI KAM Address	(Suppositor Politors) (CXI RANG) Sutur	
76543210	A4A3A2A1A0	765 43210	
0000**00	0 0 0 0 0 1 0 1 0 0 0 1 1 1 0 0 1 0 1 1 1 0 1 1 1	XXX 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	——————————————————————————————————————
0000**01	000 001 010 011 00 100 101 110	XXX 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	

17. Instruction Set

Instruction operation

						Co	ode						Executes Cycle "
			RS	D87	DB6	085	084	083	DB3	061	080	Descriptor.	
Instruction Status	SR	1	0	8F	AC	AC	AC	AC	AC	AC	AC	Reads busy flag (BF), which indicates internal operations are being performed, and reads address counter (AC).	0
Clear display	CL	0	0	0	0	0	0	0	0	0	1	Clears entire display and sets DDRAM address 0 in address counter.	310
Return	СН	0	0	0	0	0	0	0	0	1	0	Sets DDRAM address 0 in address counter.	10
home Start	os	0	0	0	0	0	0	0	0	1	1	Starts oscillation during standby mode.	
entry mode set	EM	0	0	Q.	0	0	0	0	1	ND	OSC	Sets address update direction after RAM access (I/D), and system dlock division (OSC).	10
Cursor control	CR	0	Ö	0	0	0	Ç	1	B/W	С	8	Sets black-white inverting cursor (B/W), 8th rester- row cursor (C), and blink cursor (B).	10
Display on/off control	00	٥	0	0	0	0	1	0	DC	D8	LC	Sets character display on/off (DC), segment display on/off (DS), and line-cursor on/off (LC).	10
Power control	PW	0	0	0	0	G	1	1	AMI	SLF	STE	Turns on voltage-follower and booster (AMP), and sets sleep mode (SLP) and standby mode (STB).	10
Display control	00	0	0	¢	. 0	1	ML	NLC	DL3	DL	2 OL.1	Sets the rember of displatines (NL) and the line to be doubled in height.	y 10 ,
Contrast control	ÇA	1 0	0	0	1	0	SN	2 CT	CT	2 CT	1 CT	 Sets the display-start line (SN2) and contrast- adjusting value (CT). 	10
Scroll control	SC	0	0	0	1	1	6N	1 SN	SLZ	SL.	1 SL	Sets the display-start line (SN) and display-start raster-row (SL).	10
Annunciat /SEGRAM address sc)	0	0	1	0	O	O.A				N/ AA		10
CGRAM address s	C/ et	٥ ۸	0	1	0	1	Ą	n Acc	A ₀₀	₁ A ₀	a, A _o ,	Sets the initial CGRAM address to the address counter.	10
DDRAM address a (upper bits		0	0	1	1	0	0	0	0	Λ,	on ^or	Sets the initial higher DDRAM address to the address counter.	10
DDRAM address s (lower bits		۰ 0	0	1	1	1	Α,	o4 A 04	xx A ₀₀	. 4	D1 A 04	Sets the initial lower DDFIAM address to the address counter.	10

						C		Execution					
population	No.	R/W	RS	087	DB6	DBS	D84	DB3	D82	061	DBo	Description	Cycle *1
Write date to RAM	WD	Ø	1			Write	date			****	- ·	Writes date to DDRAM, CGRAM, SEGRAM, or annunciator.	10
Read data from FIAM	AD.	1	1		•	Rest	data					Reads data from DORAM, CGRAM, or SEGRAM.	10
	8F	= 1:	Inten	nally of	peratirs	g				AC:	Addr	ass counter	
		= 1 :		em cloc						NO	= 0:	Decrement	
	8 8 D	= 1 :	Blick	k-white cumper lay on		uð cm	BOT OR			С	= 1:	8th raster-row cursor on	
	DC	= 1 :	Char	acter d contain			. Curbo	r attrib	ult	06	= 1:	Segment display on	
	AMP STB	= 1: = 1:	Volta: Stan	ge-folk Dy ma	ower a de	nd boo	eter o	n				Sleep mode	
			10: 3	ines (1/26 di	aty rath	0),11:4	i linee	(1/34	luty re	iio)j	lines (1/18 duty ratio),	
	СТЗ~	10: 3 lines (1/25 duty ratio),11:4 lines (1/34 duty ratio)] DL1: Double-height lines (DL1 = 1: 1st line, DL2 = 1: 2nd line, DL3 = 1: 3nd line) CT0: Contrast adjustment											
•	SL2 -	- 21'0;	Diept	ay-star	t reate:	r⊣ow ((st line, 000: 1:	001: 2 et rask	ind line M-Now.	, 010: 111;	3rd lin 8th re	s, 011; 4th tine, 100; 5th line) ster-row)	, ² ,
	AAN/ ACG4	A _{rea} # IACG	0000- 0: C	OCIO: OCIO: CGRAM CRAM	Annun addra	cintor : es. (00	000-1	1111)	11)	AAN	A	= 1000-1111: SEGRAM add	irees .

Note: 1. Represented by the number of operating clock pulses; the execution time depends on the supplied clock frequency or the internal oscillation frequency.